502900467 07/21/2014

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT2947064

| SUBMISSION TYPE: | NEW ASSIGNMENT |
|-----------------------|----------------|
| NATURE OF CONVEYANCE: | ASSIGNMENT |

CONVEYING PARTY DATA

| Name | Execution Date |
|-------------|----------------|
| I-TSENG LEE | 06/19/2014 |
| YI HSIU LIU | 06/19/2014 |

RECEIVING PARTY DATA

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|-------------------|---|
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| City: | PUDONG DISTRICT, SHANGHAI |
| State/Country: | CHINA |
| Postal Code: | 201203 |

PROPERTY NUMBERS Total: 1

| Property Type | Number |
|---------------------|----------|
| Application Number: | 14159813 |

CORRESPONDENCE DATA

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| ATTORNEY DOCKET NUMBER: | 100100.120137 |
|-------------------------|---------------------|
| NAME OF SUBMITTER: | MICHELLE L. DAVIS |
| SIGNATURE: | /michelle I. davis/ |
| DATE SIGNED: | 07/21/2014 |

Total Attachments: 4

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PATENT 502900467 REEL: 033354 FRAME: 0402

AMD Reference No. 120137

ASSIGNMENT OF PATENT RIGHTS

This is an assignment of patent rights between inventor(s) I-Tseng Lee and Yi Hsiu Liu (hereinafter referred to as the "Inventor(s)") and Advanced Micro Devices (Shanghai) Co. Ltd., having a place of business at Bldg# 48 River Front Harbor, Zhangjiang Hi-Tech Park, No.1387 Zhangdong Rd., Pudong District, Shanghai, China 201203 (hereinafter referred to as the "Assignee").

WHEREAS, Inventor(s) are named as inventors in the patent application filed in China on January 21, 2013, entitled A DIE-DIE STACKING STRUCTURE AND METHOD FOR MAKING THE SAME, having application no. 201310021655.2 and having a docket number of 120137 (hereinafter referred to as the "Application"); and

WHEREAS, Assignee has a desire to acquire all rights, title, and interest in the invention(s) disclosed in the Application (hereinafter referred to as the "Invention(s)"), including any rights, title, and interest in the Invention(s) not previously transferred to Assignee through prior agreement.

NOW, THEREFORE, the parties agree as follows:

- 1. To the extent that Inventor(s) are subject to a prior agreement transferring rights, title, and/or interest in the Invention(s) to the Assignee, Inventor(s) hereby confirm such transfer.
- 2. To the extent that Inventor(s) retain any rights, title, or interest in the Invention(s) not vested in the Assignee on the date(s) of execution of this Assignment, Inventor(s) hereby assign and otherwise transfer to the Assignee their entire right, title, and interest, throughout the world, in and to: the Invention(s), including any patent applications, patents, invention registrations, and equivalents thereof (including any and all provisional, international, regional, and national patents and patent applications, and all divisions, continuations, continuations-in-part, renewals, reissues, reexams, substitutes and extensions thereof), for the Invention(s) and all rights to claim priority thereto. Inventor(s) further assign and otherwise transfer to Assignee all causes of action and remedies arising under any patent or patent application for the Invention(s) prior to, on,

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or after the date(s) of execution of this Assignment. Inventor(s) shall not be entitled to an accounting for any causes of action or remedies pursued by Assignee.

- 3. The transfers set forth in Paragraphs 1 and 2 above are in consideration for the sum of at least one U.S. dollar (US\$1) (or its equivalent) and/or other consideration for which both parties acknowledge to be valuable. Such consideration includes but is not limited to at least one of the following: employment, an independent contractor agreement, monetary payment, or other benefit hereby acknowledged as received.
- 4. Inventor(s) hereby authorize and request the Commissioner of Patents and Trademarks, or equivalent thereof, to issue the patent for the Invention, and all resulting patents therefrom, insofar as the Inventor(s)' interest is concerned, to the Assignee.
- 5. Inventor(s) further agree to execute any and all powers of attorney, applications, assignments, declarations, affidavits, and any other papers in connection therewith necessary to perfect Assignee's rights, title, and interest in the Invention(s).
- 6. Inventor(s) hereby authorize Assignee, its successors and assigns, its legal representatives, or anyone the Assignee may properly designate, to insert in this Assignment of Patent Rights the filing date and/or application number of the Application when ascertained.
- 7. Inventor(s) hereby further agree to, with respect to any patent application or patent for the Invention(s), at the expense of the Assignee:
 - i) testify in any legal proceedings,
 - ii) sign all lawful papers,
 - iii) execute all divisional, continuation, continuation-in-part, reissue, reexamination, and substitute applications,
 - iv) make all lawful oaths, and assist in vesting title in the Assignee and to aid the Assignee to obtain and enforce proper protection for the subject matter of the Invention(s) in all countries and regions, and
 - v) notify Assignee promptly (by facsimile or first class mail) of any subpoena or contact by any person other than Assignee or its agents regarding the Invention or resultant patent(s) issuing therefrom, and in any event at least one week prior to any deposition, legal inquiry or legal proceeding relating to the above identified invention.

PATENT REEL: 033354 FRAME: 0404 This assignment is executed on the date(s) of which the Inventor(s) have signed.

| Inventor: | | | |
|----------------------------|---------------------------------|---------|------------------|
| 1-Tsenf Lee I-TSENG LEE | _ (Signature) _ (Print Name) | 6/19 14 | _(Date |
| Witness # 1: | | | |
| Yn-Ling Hsieh | _(Signature) _(Print Name) | - 49 14 | _ (Date) |
| Witness # 2: | | | |
| Cheng Hua Fan | _(Signature) _(Print Name) | 6/19/14 | _(Dat e) |

| Inventor: | | |
|------------------------------------|---------------------------------|------------------------|
| Y. Hora Lau (Mike Gru) YI HSIU LIU | _ (Signature) _ (Print Name) | June - 19, >014 (Date) |
| Witness # 1: | | |
| Juling Hach | (Signature) (Print Name) | <u> </u> |
| Witness # 2: | | |
| Cheng Hua Fan Cheng Hua Fan | (Signature) (Print Name) | 6/19 (14 (Date) |

RECORDED: 07/21/2014

PATENT REEL: 033354 FRAME: 0406